

S	SPECIFICATIONS				
CUSTOMER	:				
SAMPLE CODE	SH480272T0	05-IHC03			
MASS PRODUCTION CODE	PH480272T0	05-IHC03			
SAMPLE VERSION	01				
SPECIFICATIONS EDITION	004				
DRAWING NO. (Ver.)	LMD-PH4802	72T005-IHC03 (Ver.001)			
PACKAGING NO. (Ver.)	PKG-PH4802	72T005-IHC03 (Ver.001)			
	ustomer Approved				
Approved	Checked	Date: Designer			
Approved 黃秋源 Oliver Huang					
黃秋源	Checked 石建莊 Stone Shin	<b>Designer</b> 王聖硯			
黃秋源 Oliver Huang □ Preliminary specification for ■ Specification for sample app	Checked 石建莊 Stone Shin	Designer 王聖硯 Stephen Wang POWERTIP 2019.11.28 TW RD APR			



## History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by		
12/18/2017	01	001	New Drawing - Steph				
03/20/2018	01	002	New Sample - Steph				
08/30/2019	01	003	Added 1.8 items 11 Ste				
11/20/2019	01	004	Update Spec Modify the content of the title 1.3 Create the MOSFET for BL circuit	Modify the content of the title 1.3 5			

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## 1. SPECIFICATIONS

#### 1.1 Features

Item	Standard Value					
Display Resolution	480 *3 (RGB) * 272 Dots					
LCD Type	a-Si TFT, Normally white, Transmissive type					
Screen Size(inch)	4.3 inch					
Viewing Direction	6 O'clock					
Color Configuration	RGB - Strip					
Touch Panel	Projective Capacitive Touch Panel USB HID Touch					
Weight	103.4 g					
Backlight Type	White LED B/L					
Interface	HDMI					
Controller/Driver IC	HYCON 4635					
	THIS PRODUCT CONFORMS THE ROHS OF PTC					
ROHS	Detail information please refer website :					
	http://www.powertip.com.tw/news_detail.php?Key=1&cID=1					

## **1.2 Mechanical Specifications**

Item	Standard Value	Unit
Outline Dimension	105.5 (W) * 67.2 (L) * 15.76 (H)	mm

LCD panel

Item	Standard Value	Unit
Active Area	95.04 (W) * 53.856 (L)	mm

**Touch Panel** 

Item	Standard Value	Unit
Viewing Area	97.9 (W) * 56.2 (L)	mm

Note : For detailed information please refer to LCM drawing.



#### 1.3 Absolute Maximum Ratings

#### Module

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply for Digital Circuit	VBus	GND=0V	-0.3	+6.0	V
Operating Temperature	Top (Ts)	Note 1	-20	+70	°C
Storage Temperature	Ts⊤(Ta)	Note 2	-30	+80	°C

Note 1 : Ts is the temperature of panel's surface

Note 2: Ta is the ambient temperature of samples

The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

#### 1.4 DC Electrical Characteristics

Module					$GND = 0V$ , $Ia = 25^{\circ}C$			
Item	Symbol	Min.	Тур.	Max.	Unit	Remark		
Input Signal Voltage	VBus	4.75	5.0	5.25	V	Note		
Supply Current	IVBus	350	370	450	mA	Pattern = Full Display		

Note1: The customer has to check the input current is greater than 1.5A.

Note2: Supply voltage which is included backlight drive.

Note3: Maximum current for RGB screen, full display.



## **1.5 Optical Characteristics**

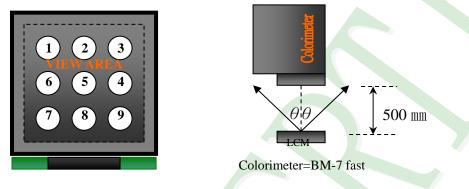
### TFT I CD Module

TFT LCD Module							Та	a=25°C
Item		Symbol	nbol Condition		Тур.	Max.	unit	
Deenenee Time	Rise	Tr	Ta = 25°C	-	10	20	177.0	Note 2
Response Time	Fall	Tf	$\theta X, \theta Y = 0^{\circ}$	-	15	30	ms	Note 2
	Тор	θY+		-	60	-		
	Bottom	θY-	CR ≥ 10	-	60	-	Dog	Note 4
Viewing Angle	Left	θX-	CR 2 10	-	60	-	Deg.	Note 4
	Right	θX+		-	60	-		
Contrast Ration	C	CR		500	600	-	-	Note 3
	\A/b:ta	Х		0.25	0.30	0.35		
	White	Y		0.29	0.34	0.39		
	Ded	X Y	<b>T</b> 0500	0.51	0.59	0.64		
Color of CIE	Red		Ta = 25°C θX , θY = 0°	0.31	0.36	0.41		Niete 1
Coordinate (With B/L)	Croop	Х	0X, 01 = 0	0.28	0.33	0.38	-	Note1
( )	Green	Y		0.53	0.58	0.63		
	Dhua	Х		0.10	0.15	0.20		
	Blue	Y		0.05	0.10	0.15		
Average Brightn	ess							
Pattern=White Dis	splay	IV		680	850		cd/m <sup>2</sup>	Note1
(With LCD) *1		IV	VBus=5.0V	000	000	-	cu/m-	NOLET
			PWM="High"					
Uniformity			(Duty=100%)					
(With LCD)	*2	∆B		70	-	-	%	Note1
(With EOD)	-							



Note 1:

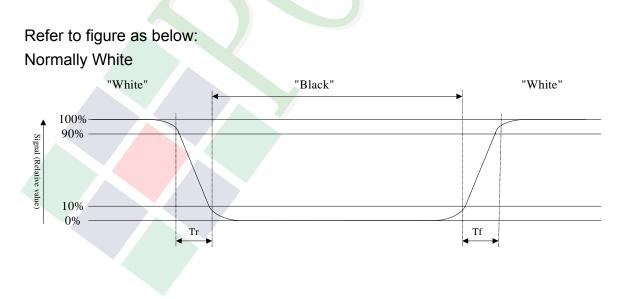
- \*1 : △B=B(min) / B(max) \* 100%
- \*2 : Measurement Condition for Optical Characteristics:
  - a : Environment: 25°C±5°C / 60±20%R.H , no wind , dark room below 10 Lux at typical lamp current and typical operating frequency.
  - b : Measurement Distance: 500 ± 50 mm  $\rightarrow$  (0= 0°)
  - c : Equipment: TOPCON BM-7 fast , (field 1°) , after 10 minutes operation.
  - d: The uncertainty of the C.I.E coordinate measurement ±0.01 , Average Brightness ± 4%



To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

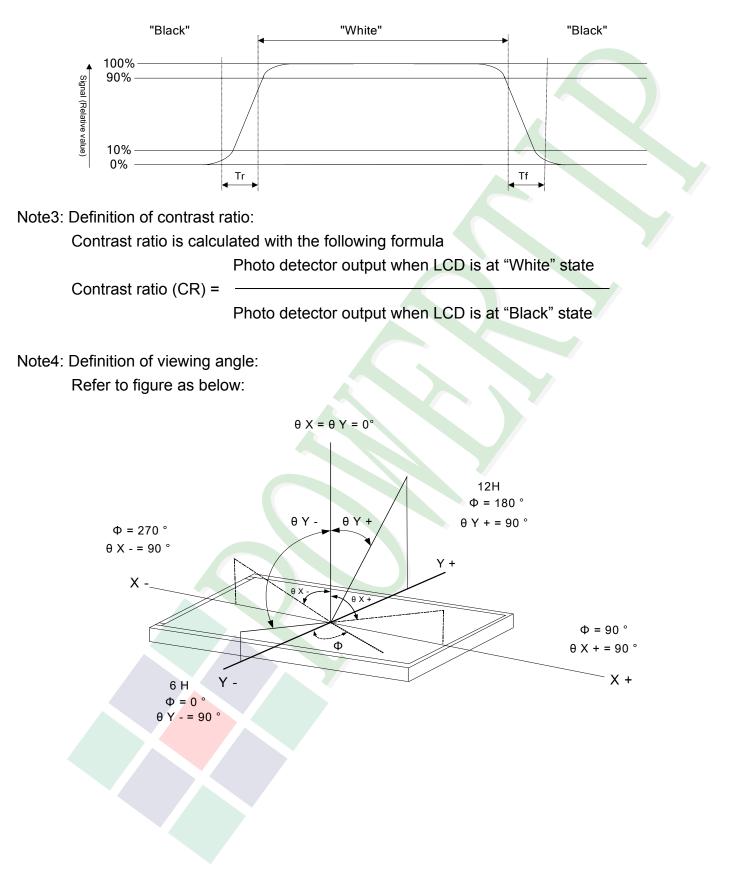
Note2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white"(falling time) and from "white" to "black"(rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.





Normally Black





#### **Backlight Characteristics** 1.6

#### **Maximum Ratings**

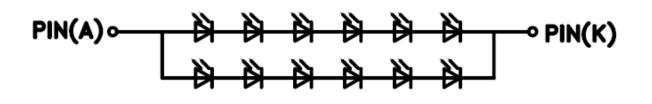
Item	Symbol	Min.	Max.	Unit	Remark
LED Forward Current	lF	3	0	mA	
LED Reverse Voltage	VR	Ę	5	V	One LED
Power Dissipation	PD	12	24	mW	

#### **Electrical / Optical Characteristics**

Electrical / Optical Chara	acteristics						
Item	Symbol	Condition	Min.	Тур.	Max.	Unit	Remark
Forward Voltage	VF	IF=40mA	17.6	19.2	20.4	V	Note1
LED Life Time	-		50000		-	hr	Note2
Color			White				

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25 °C.

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25 °C and I∟=40 mA. The LED life time could be decreased if operating I∟ is larger than 40 mA.





### 1.7 Touch Panel Characteristics

#### Features

Item	Standard Value
Touch Panel Size	4.3"
Touch Type	Projective Capacitive Touch Panel
Input Method	Finger / 5 Points Touch
Interface	l <sup>2</sup> C
IC	HYCON4635
I <sup>2</sup> C Address	0x38 (7-bit)

#### I<sup>2</sup>C Address

107.00							
Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	1	1	1	0	0	0	R/W
Bit 0: 0	for Write /	1 for Read					

## Mechanical Specifications

Item	Standard Value	Unit
Active Area	98.1 (W) * 56.9 (L)	mm
Number of Sensing Channel	18 * 10	

#### Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Supply Voltage	TP_VDD	-	-0.3	+6.0	V
Operating Temperature	Тор	-	-20	+70	°C
Storage Temperature	Tst	-	-30	+80	°C

#### **DC Electrical Characteristics**

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	TP_VDD	-	-	3.3	-	V

#### Touch Panel IC Read/Write description & Register Mapping

Reference: HYCON Touch Driver Porting Reference Guide.



#### **1.8 HYCON I<sup>2</sup>C Sensitivity command:**

Address	ss Register description		Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0
0x92	GAIN	R/W		Sens	itivity s	etting,	setting	range	: 05	

#### Application reference:

Register 0x92=02(Default)

without cover lens

Caution!

At different cover lens thickness can lead to touch Sensitivity changed (e.g. ghost-touches).

Therefore, the touch needs to be thoroughly tested in the target application.

PTC application design suggestion is only for reference, please adjust based on your final design.

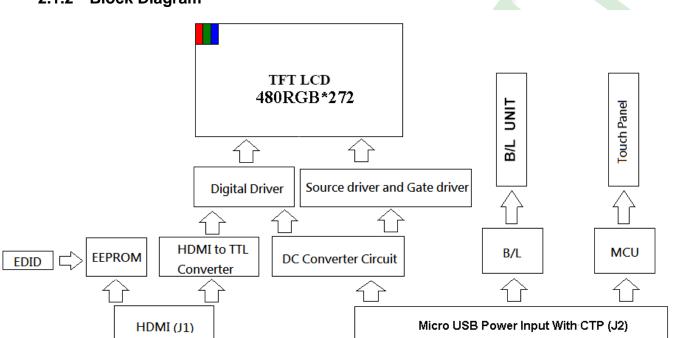


## 2. MODULE STRUCTURE

### 2.1 Counter Drawing

#### 2.1.1 LCM Mechanical Diagram

- \* See Appendix
- 2.1.2 Block Diagram





## 2.2 Interface Pin Description

## 2.2.1 (J1:HDMI 1.3 A type Interface)

Pin#	Name	Description		
1	TX2+	TMDS Data 2+		
2	TX2 Shield	TMDS Data 2 Shield		
3	TX2–	TMDS Data 2-		
4	TX1+	TMDS Data 1+		
5	TX1 Shield	TMDS Data 1 Shield		
6	TX1–	TMDS Data 1-		
7	TX0+	TMDS Data 0+		
8	TX0 Shield	TMDS Data 0 Shield		
9	TX0–	TMDS Data 0-		
10	TXC+	TMDS Clock+		
11	TXC Shield	TMDS Clock Shield		
12	TXC–	TMDS Clock-		
13	CEC	CEC		
14	NC	No connection		
15	SCL	Serial Clock for DDC		
16	SDA	Serial Data for DDC		
17	GND	Power ground		
18	V5V	+5V Power		
19	Hot Plug Detect	Hot Plug Detect		



#### 2.2.2 (J2:Micro USB Power Input & Capacitive Touch Panel Interface)

Pin#	Name	Description		
1	VBus	VBus 4.75V-5.25V		
2	D-	Data-		
3	D+	Data+		
4	ID	No connection		
5	GND	Power ground.		



#### 2.3 HDMI Characteristics

#### 2.3.1 Signal DC&AC Characteristics

#### DC ELECTRICAL CHARACTERISTICS

over operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP MAX	UNIT
VID	Analog input differential voltage <sup>(1)</sup>		75	1200	mV
VIC	Analog input common-mode voltage <sup>(1)</sup>		$AV_{DD} - 300$	$AV_{DD} - 37$	mV
V <sub>I(OC)</sub>	Open-circuit analog input voltage		$AV_{DD} - 10$	AV <sub>DD</sub> + 10	mV
I <sub>DD(2PIX)</sub>	Normal 2-pix/clock power supply current (2)	ODCK = 82.5 MHz, 2-pix/clock		370	mA
I <sub>PD</sub>	Power-down current (3)	PD = low		10	mA
I <sub>PDO</sub>	Output drive power-down current <sup>(3)</sup>	PDO = low		35	mA

Specified as dc characteristic with no overshoot or undershoot (1)

Alternating 2-pixel black/2-pixel white pattern. ST = high, STAG = high, QE[23:0] and QO[23:0] CL = 10 pF. (2)

Analog inputs are open circuit (transmitter is disconnected from TFP401/401A). (3)

#### AC ELECTRICAL CHARACTERISTICS

over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	түр	MAX	UNIT		
VID(2)	Differential input sensitivity <sup>(1)</sup>		150		1560	m∨ <sub>p-p</sub>		
t <sub>ps</sub>	Analog input intra-pair (+ to –) differential skew <sup>(2)</sup>				0.4	t <sub>bit</sub> <sup>(3)</sup>		
t <sub>ccs</sub>	Analog input inter-pair or channel-to-channel skew <sup>(2)</sup>				1	t <sub>pix</sub> <sup>(4)</sup>		
t <sub>ijit</sub>	Worst-case differential input clock jitter tolerance <sup>(2)(5)</sup>		50			ps		
t.	Fall time of data and control signals <sup>(6)(7)</sup>	ST = low, C <sub>L</sub> = 5 pF			2.4 ns			
t <sub>f1</sub>	Fail time of data and control signals (30)	ST = high, C <sub>L</sub> = 10 pF			1.9	115		
+	Rise time of data and control signals <sup>(6)(7)</sup>	ST = low, C <sub>L</sub> = 5 pF			2.4	ns		
<b>Ļ</b> 1	Rise time of data and control signals (A)	ST = high, C <sub>L</sub> = 10 pF			1.9	115		
+ -	Rise time of ODCK clock <sup>(6)</sup>	ST = low, C <sub>L</sub> = 5 pF			2.4	ns		
t <sub>2</sub>	Rise time of ODCK Clock · ·	ST = high, C <sub>L</sub> = 10 pF			1.9	115		
	Fall time of ODCK clock <sup>(6)</sup>	ST = low, C <sub>L</sub> = 5 pF			2.4			
t <sub>f2</sub>		ST = high, C <sub>L</sub> = 10 pF			1.9	ns		
		1 pixel/clock, PIXS = low, OCK_INV = low	1.8					
t <sub>su1</sub>	Setup time, data and control signal to falling edge of ODCK	2 pixel/clock, PIXS = high, STAG = high, OCK_INV = low	3.8			ns		
		2 pixel and STAG, PIXS = high, STAG = low, OCK_INV = low	0.7					
		1 pixel/clock, PIXS = low, OCK_INV = low	0.6					
t <sub>h1</sub>	Hold time, data and control signal to falling edge of ODCK	2 pixel and STAG, PIXS = high, STAG = low, OCK_INV = low	2.5			ns		
		2 pixel/clock, PIXS = high, STAG = high, OCK_INV = low	2.9					

(1) Specified as ac parameter to include sensitivity to overshoot, undershoot and reflection.

(2) By characterization

(3)

to the tis 1/10 the pixel time, tpix tpix is the pixel time defined as the period of the RxC input clock. The period of ODCK is equal to tpix in 1-pixel/clock mode or 2tpix when in 2-pixel/clock mode. (4)

Measured differentially at 50% crossing using ODCK output clock as trigger (5)

Rise and fall times measured as time between 20% and 80% of signal amplitude. (6)

(7)Data and control signals are QE[23:0], QO[23:0], DE, HSYNC, VSYNC. and CTL[3:1].



#### AC ELECTRICAL CHARACTERISTICS (continued)

over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT		
		1 pixel/clock, PIXS = low, OCK_INV = high	2.1					
t <sub>su2</sub>	Setup time, data and control signal to rising edge of ODCK	2 pixel/clock, PIXS = high, STAG = high, OCK_INV = high	4			ns		
		2 pixel and STAG, PIXS = high, STAG = low, OCK_INV = high	1.5					
		1 pixel/clock, PIXS = low, OCK_INV = high	0.5					
t <sub>h2</sub>	Hold time, data and control signal to rising edge of ODCK	2 pixel and STAG, PIXS = high, STAG = low, OCK_INV = high	2.4			ns		
		2 pixel/clock, PIXS = high, STAG = high, OCK_INV = high	2.1					
	ODOK frequency	PIX = low (1-PIX/CLK)	LK) 25 16		165	MHz		
fodck	ODCK frequency	PIX = high (2-PIX/CLK)	12.5		82.5	MHZ		
	ODCK duty-cycle		40%	50%	60%			
t <sub>pd(PDL)</sub>	Propagation delay time from PD low to Hi-Z outputs				9	ns		
t <sub>pd(PDOL)</sub>	Propagation delay time from PDO low to Hi-Z outputs				9	ns		
t <sub>t(HSC)</sub>	Transition time between DE transition to SCDT low <sup>(8)</sup>			1e6		t <sub>pix</sub>		
t <sub>t(FSC)</sub>	Transition time between DE transition to SCDT high <sup>(8)</sup>			1600		t <sub>pix</sub>		
t <sub>d(st)</sub>	Delay time, ODCK latching edge to QE[23:0] data output	STAG = low, PIXS = high		0.25		t <sub>pix</sub>		

(8) Link active or inactive is determined by amount of time detected between DE transitions. SCDT indicates link activity.





#### 2.3.2 Parameter Measurement Information

#### PARAMETER MEASUREMENT INFORMATION

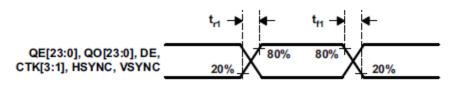
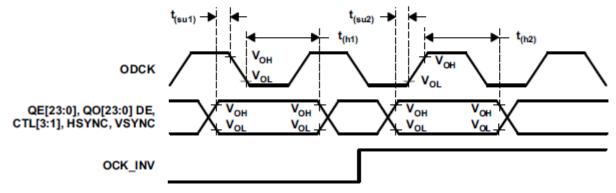


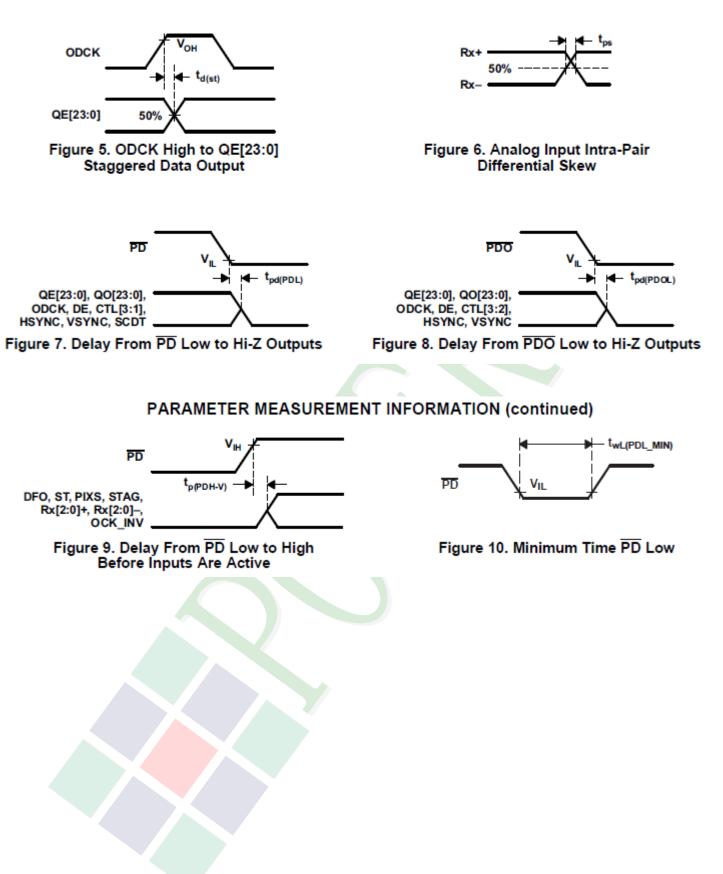
Figure 1. Rise and Fall Times of Data and Control Signals





#### Figure 4. Data Setup and Hold Times to Rising and Falling Edges of ODCK







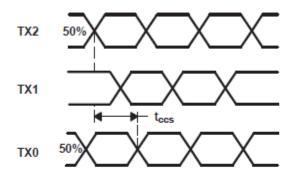


Figure 11. Analog Input Channel-to-Channel Skew

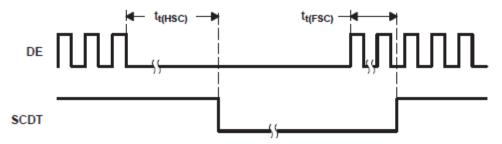


Figure 12. Time Between DE Transitions to SCDT Low and SCDT High

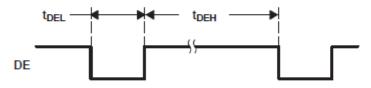


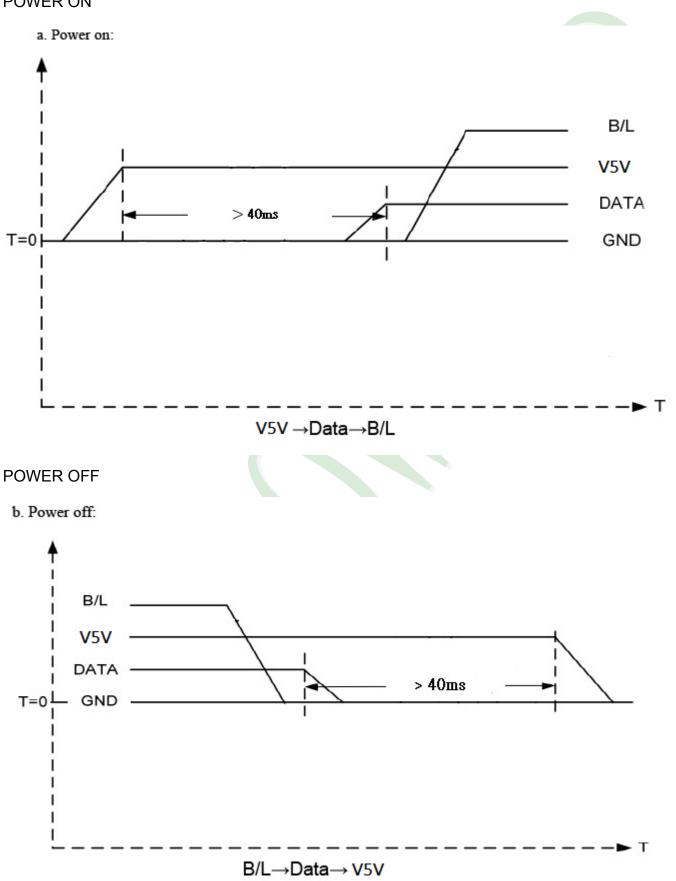
Figure 13. Minimum DE Low and Maximum DE High

#### DETAILED DESCRIPTION





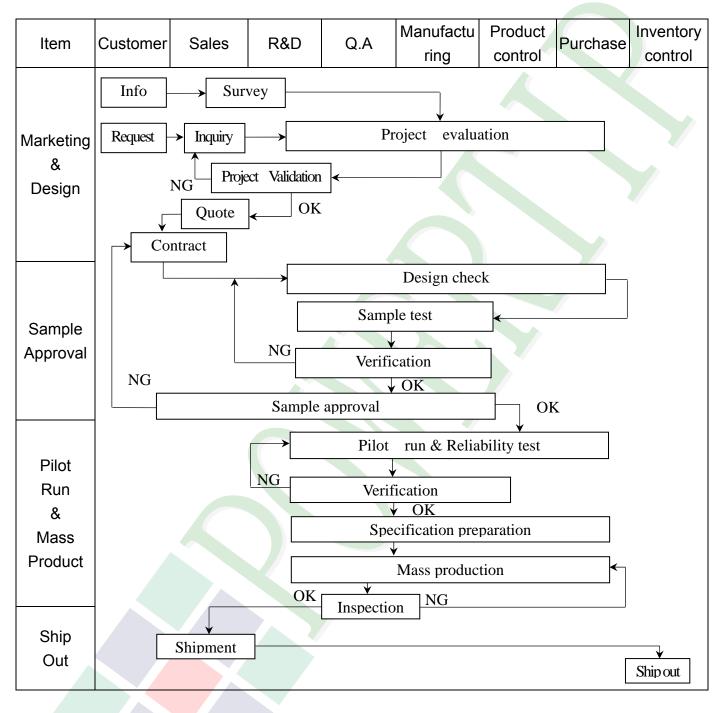
2.3.3 Power Sequence POWER ON





## **3. QUALITY ASSURANCE SYSTEM**

## 3.1 Quality Assurance Flow Chart



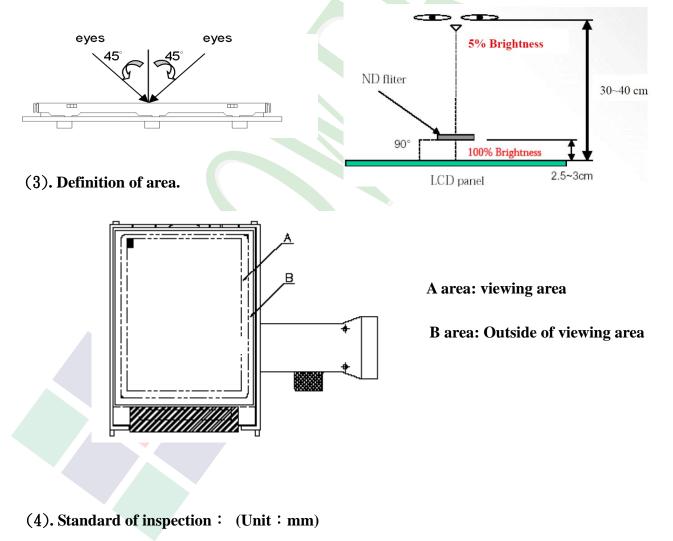


Item	Customer	Sales	R&D	Q.A	Manufact uring	Product control	Purchase	Inventory control
Sales Service	Info	► Claim sis report	[	Trackin	Failure an Corrective			
Q.A Activity	1. ISO 900 3. Equipme 5. Standard	ent calibrati	ion	4	Process in Education	•		es

# **POWERTIP**

## **3.2. Inspection Specification**

- Scope: The document shall be applied to TFT-LCD Module for 3. 5" -15'' (Ver.B01).
- $\clubsuit$ Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level II.
- **•**Equipment: Gauge, MIL-STD, Powertip Tester, Sample
- Defect Level: Major Defect AQL: 0. 4; Minor Defect AQL: 1.5
- ♦OUT Going Defect Level: Sampling.
- **♦**Standard of the product appearance test:
  - a. Manner of appearance test:
  - (1). The test best be under 20W×2 fluorescent light(about 300lux ~500lux)
    - , and distance of view must be at 30~40 cm.
  - (2). The test direction is base on about around 45° of vertical line.





## 

(Ver.B01)↔

NO∉	Item₽		<b>Criterion</b> + <sup>∂</sup>					
		1. 1The par produ		nber is inconsistent ಳಿ	with work order of	Major		
01₄⊃	Product condition.	1. 2 Mixed product types.						
		1. 3 Assem	bled i	n inverse direction.∉	1	Major		
02₽	Quantity₽	2. 1The qu	antity	is inconsistent with	work order of production.	Major₽		
03₽	Outline dimension∢		. 1Product dimension and structure must conform to structure diagram.43			Major₽		
		4. 1 Missin	4. 1 Missing line character and icon.↩					
	04 <sup>↓</sup> Electrical Testing <sup>↓</sup>	4. 2 No fun	nction	or no display.₽		Major₽		
		4. 3 Display malfunction. 🕫						
04* <sup>3</sup> El¢		4. 4 LCD viewing angle defect.↔						
		4. 5 Currer	Major₽					
				-	% ND filter at 50% Gray ↔ 1g angle of 90 degree.↩	Minore		
		له		Item₄ <sup>3</sup>	Acceptance (Q'ty)+			
				Bright Dot₊	<u>≦</u> 4₽ ₽			
	Dot defect⊷	п	Dot	Dark Dot₽	چ 5⊷			
	له	De	efect⊹	Joint Dot 🖉	્રં 3ેન્ગ ન્ગ			
05₽	(Bright dot,↩ Dark dot) ↩			Total↩	<b>≦</b> 7₽ ₽	Minor₽		
03	ب On -display	5.1 Inspec	ction ]	pattern: full white,	full black, Red, Green and			
	ب <sup>ی</sup>	blue screens. 🗸						
				as dot defect if defe				
		5. 3 The distance between two dot defect ≥5 mm.+						
		5.4 Bright	t dot t	hat can not be seen	through 5% ND filter.↔			



NO⇔	Item₊⊃				Crit	erion₽			Level	
06+3	$\Phi = (x+y) / 2e^{y}$	با 6. 2 Lin با 3.5"	Dimensio 0.25	Non-display on (diametee $\Phi \leq 0$ , $\langle \Phi \leq 0, 2$ $\Phi > 0$ Totale n-display of Length (L)e $e^{2}$ $L \leq 10.0e^{2}$ $e^{2}$ $L \leq 10.0e^{2}$ $e^{2}$	r = <b>Φ</b> )+ 25+ 50+ 50+ r displ w 0.03 0.05 Tota	AcceptarA areaIgnore $5+$ $0+$ $5+$ $0+$ $5+$ ay):+Vidth (W)+W $\leq 0.03+$ $< W \leq 0.03+$ $< W \leq 0.05+$ $< W \leq 0.10+$ W > 0.10+ $1+$ W $\leq 0.05+$ $< W \leq 0.05+$ $< W \leq 0.10+$ W > 0.10+	Acceptance Acceptance Aarea 440 240 As round type 540 Ignore 540 Ignore 540 As round type 540 Seo As round	نه نه نه	Minor	
07₽	Polarizer↓ Bubble↓	ب ا	0.25 <	(diameter: $\Phi \leq 0.25$ $\Phi \leq 0.50$ $\Phi \leq 0.80$	а а	Accepta A area Ignore 4 4	nce (Q'ty)+ B are Igno	נים בי בי	Minor	
				1	Φ >0.80 Cotal₀	ца	0₽ 5₽		م م	



Specif	ication For TFT-LCD N	Iodule 3. 5‴_~15″ =	(Ver.B01)+
NO↔	Item∻	<b>Criterion</b> ₄ <sup>2</sup>	Level₽
		بن Symbols : ب ب X: The length of crack Z: The thickness of crack t: The thickness of glass ب ب	-
		8.1 General glass chip:↔	
		8.1.1 Chip on panel surface and crack between panels:	
		$\begin{array}{c} \mathcal{A} \\ $	
<b>08</b> ₽	The crack of glass≁	$\begin{array}{cccc} & & & \\ $	Minor∉
		له (۵۸)	
		$\begin{array}{c} \downarrow \\ \downarrow $	
		$\begin{array}{c c} \bullet \\ \bullet \\ \bullet \\ \bullet \end{array} X_{,1} Y_{,2} Y_{,2} Z_{,2} \end{array} \phi^2$	
		$ \leq a^{2} \qquad \begin{array}{c} Crack \ can't \ enter \\ viewing \ area^{2} \end{array} \qquad \leq 1/2 \ t^{2} $	
		$ \leq a^{e^{j}} \leq a^{e^{j}} $ Crack can't exceed the half of SP width.	



NO₽	Item₽	Criterion.	Level
		Symbols : +/ */ X: The length of crack Z: The thickness of crack t: The thickness of glass */ 8. 1. 2 Corner crack:+/ */ */ */ */ */	
		$ \begin{array}{c c} & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ & & \\ \end{array} $	сь
		$ \stackrel{\scriptscriptstyle \leftarrow}{\underset{\scriptscriptstyle \leftarrow}{\overset{\scriptscriptstyle \leftarrow}}{\underset{\scriptscriptstyle \leftarrow}{\overset{\scriptscriptstyle \leftarrow}}{\underset{\scriptscriptstyle \leftarrow}{\overset{\scriptscriptstyle \leftarrow}}{\overset{\scriptscriptstyle \leftarrow}{\overset{\scriptscriptstyle \leftarrow}}{\underset{\scriptscriptstyle \leftarrow}{\overset{\scriptscriptstyle \leftarrow}{\overset{\scriptscriptstyle \leftarrow}{\underset{\scriptscriptstyle \leftarrow}{\overset{\scriptscriptstyle \leftarrow}{\overset{\scriptscriptstyle \leftarrow}}{\underset{\scriptscriptstyle \leftarrow}{\underset{\scriptscriptstyle \leftarrow}{\overset{\scriptscriptstyle \leftarrow}{\underset{\scriptscriptstyle \leftarrow}{\underset{\scriptscriptstyle \leftarrow}{\underset{\scriptscriptstyle \leftarrow}{\overset{\scriptscriptstyle \leftarrow}{\underset{\scriptscriptstyle \leftarrow}{\underset{\scriptstyle \leftarrow}{\underset{\scriptstyle}{\atop\atop \atop}{\underset{\scriptstyle \leftarrow}{\underset{\scriptstyle \leftarrow}{\underset{\scriptstyle \leftarrow}{\underset{\scriptstyle \leftarrow}{\underset{\scriptstyle \leftarrow}{\underset{\scriptstyle \leftarrow}{\underset{\scriptstyle \leftarrow}{\underset{\scriptstyle \leftarrow}{\underset{\scriptstyle \leftarrow}{\underset{\scriptstyle}{\atop\scriptstyle}{\atop\atop \atop \atop}{\underset{\scriptstyle}{\atop\atop\scriptstyle}{\atop\atop\scriptstyle}{\atop\atop\scriptstyle}{\underset{\scriptstyle}{\atop\scriptstyle}{\atop\scriptstyle}{\atop\scriptstyle}{\atop\scriptstyle}{\atop\scriptstyle}{\atop\scriptstyle}{\atop\scriptstyle}{\atop\scriptstyle}{\atop\scriptstyle}{$	сь.
		$ \stackrel{\text{\tiny def}}{=} \leq 1/5  a_{\text{\tiny def}}  \begin{array}{c} \text{Crack can't exceed the} \\ \text{half of SP width.} \\ \text{\tiny def} \end{array}  1/2  t < Z  \leq 2  t \in \mathbb{C} $	¢7
08₽	The crack of glass₽	₽ 8.2 Protrusion over terminal:	Minor
		8.2.1 Chip on electrode pad:	
			2
		$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	<b>]</b> ₽
			5
		$\begin{array}{c c} Back_{\psi} & \leq a_{\psi} & \leq W_{\psi} & \leq 1/2 t_{\psi} \end{array}$	42



NO Item
NO Item 08- Graciglass



#### ◆Specification For TFT-LCD Module 3. 5″~15″:

Specif	ication For TFT-L	CD Module 3. 5‴_~15″ =	(Ver.B01)+
NO <sub>4</sub> 3	Item₽	<b>Criterion</b> 4 <sup>2</sup>	Level
		9. 1 Backlight can't work normally.↔	Major₽
<b>09</b> ₽	Backlight elements≁	9. 2 Backlight doesn't light or color is wrong.↔	Major₽
		9. 3 Illumination source flickers when lit.47	Major₽
	General appearance↔	10. 1Pin type 丶 quantity 丶 dimension must match type in structure diagram.~	Major₽
		10. 2 No short circuits in components on PCB or FPC.40	Major₽
		10.3 Parts on PCB or FPC must be: no wrong parts, missing parts or excess parts.43	Majorø
<b>10</b> ⊷		10. 4 Product packaging must the same as specified on packaging specification sheet.43	Minor∉
		10.5 The folding and peeled off in polarizer are not acceptable.43	Minor₽
		10. 6 The PCB or FPC between B/L assembled distance(PCB or ↔ FPC ) is ≤1.5 mm.↔	Minor₄



## 4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

TEST ITEMHigh Temperature Storage TestLow Temperature Storage TestHigh Temperature / High Humidity Storage TestTemperature Cycling Storage Test	TEST COKeep in +80 ±5°C 240 hrsKeep in -30 ±5°C 240 hrsKeep in +60 °C / 90% R.H duration (Excluding the polarizer)-30°C $\rightarrow$ +25°C - (30mins) (5mins)20 CAir Discharge: 	n for 240 hrs $\Rightarrow +80^{\circ}C \rightarrow +25^{\circ}C$ (30mins) (5mins)		
Storage TestLow TemperatureStorage TestHigh Temperature /High HumidityStorage Test	Keep in -30 $\pm 5^{\circ}$ C 240 hrsKeep in +60 $^{\circ}$ C / 90% R.H duratio (Excluding the polarizer)-30 $^{\circ}$ C $\rightarrow$ +25 $^{\circ}$ C - (30mins) (5mins)20 CAir Discharge:	$\Rightarrow +80^{\circ}C \rightarrow +25^{\circ}C$ (30mins) (5mins) ycle		
Storage Test High Temperature / High Humidity Storage Test Temperature Cycling	Keep in +60 °C / 90% R.H duratio (Excluding the polarizer) -30°C → +25°C - (30mins) (5mins) 20 C Air Discharge:	$\Rightarrow +80^{\circ}C \rightarrow +25^{\circ}C$ (30mins) (5mins) ycle		
High Humidity Storage Test Temperature Cycling	(Excluding the polarizer) -30°C → +25°C - (30mins) (5mins) 20 C Air Discharge:	$\Rightarrow +80^{\circ}C \rightarrow +25^{\circ}C$ (30mins) (5mins) ycle		
	(30mins) (5mins) 20 C Air Discharge:	(30mins) (5mins) ycle		
	J. J	Contact Discharge:		
ESD Test	Apply 2 KV with 5 timesDischarge for each polarity +/-1.Temperature ambiance : 15°C ~32.Humidity relative : 30% ~60%3.Energy Storage Capacitance(Cs+4.Discharge Resistance(Rd) : 330 Ω5.Discharge, mode of operation :Single Discharge (time between su (Tolerance if the output voltage ind	Cd):150pF±10% ±10% accessive discharges at least 1 sec)		
Vibration Test (Packaged)	<ul> <li>1.Sine wave 10~55 Hz frequency (1 min/sweep)</li> <li>2.The amplitude of vibration :1. 5 mm</li> <li>3.Each direction (X 、 Y 、 Z) duration for 2 Hrs</li> </ul>			
Drop Test	Packing Weight (Kg)           0 ~ 45.4           45.4 ~ 90.8           90.8 ~ 454           Over 454	122           76           61           46		
	(Packaged)	Vibration Test (Packaged)2. The amplitude of vibration :1. 5 m 3. Each direction (X \sqrt{Y \sqrt{Z}}) duratiDrop Test (Packaged)Packing Weight (Kg)0 ~ 45. 490. 8 ~ 454		

**OResult Evaluation Criteria** :

Under the display quality test conditions with normal operations with normal operation state. Do not change these conditions as such changes may affect practical display function.

(Normal operation state) Temperature: +20~30°C Humidity: 50~70%

Atmospheric pressure: 86~106Kpa



## **5. PRECAUTION RELATING PRODUCT HANDLING**

#### 5.1 SAFETY

- 5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

#### **5.2 HANDLING**

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is  $320\pm10^{\circ}$ C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM .

#### 5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is  $25^{\circ}C \pm 5^{\circ}C$  and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush , shake , or jolt the module.

#### 5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.

